

Sinai Power Technologies

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N-channel Power MOSFET

PRODUCT SUMMARY

| V _{DS} (V) at TJ max. | 700 | | | |
|--|----------------------|-----|--|--|
| $R_{DS(on)}$ max. at 25°C (Ω) | V _{GS} =10V | 1.3 | | |
| Q _g max. (nC) | 42 | | | |
| Q _{gs} (nC) | 6 | 6 | | |
| Q _{gd} (nC) | 1 | 2 | | |
| Configuration | sing | gle | | |





TO-251

matic diagram

Features

- ID=7A(Vgs=10V)
- Ultra Low Gate Charge
- Improved dv/dt Capability
- 100% Avalanche Tested
- RoHS compliant

Applications

- Switching Mode Power Supplies (SMPS)
- PWM Motor Controls
- DC to DC Converters
- LED Lighting
- Bridge Circuits

| ORDERINGINFORMATION | | | | |
|---------------------|----------|--|--|--|
| Device | SPE7N65G | | | |
| Device Package | TO-251 | | | |
| Marking | 7N65G | | | |

| ABSOLUTE MAXIMUM RATINGS (Tc = 25°C, unless otherwise noted) | | | | | |
|--|-----------------------------------|--------------|------|--|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain to Source Voltage | V _{DSS} | 650 | V | | |
| Continuous Drain Current (@Tc=25°C) | | 7 | A | | |
| Continuous Drain Current (@T _C =100°C) | | 4.5 | Α | | |
| Drain current pulsed ⁽²⁾ | I _{DM} | 28 | Α | | |
| Gate to Source Voltage | V _{GS} | 30 | V | | |
| Single pulsed Avalanche Energy ⁽³⁾ | E _{AS} | 367 | mJ | | |
| Peak diode Recovery dv/dt ⁽⁴⁾ | dv/dt | 6 | V/ns | | |
| Total power dissipation ($@T_{C}=25^{\circ}C$) | D | 166 | W | | |
| Derating Factor above 25°C | P _D | 1.33 | W/ºC | | |
| Operating Junction Temperature & Storage Temperature | T _{STG} , T _J | -55 to + 150 | °C | | |
| Maximum lead temperature for soldering purpose | TL | 260 | °C | | |
| Mounting torque ⁽⁵⁾ | | 0.4~0.6 | N.m | | |

Notes

- 1. Drain current is limited by maximum junction temperature.
- 2. Repetitive rating : pulse width limited by junction temperature.
- 3. L = 15mH, I_{AS} = 7A, V_{DD} = 50V, R_G =25 Ω , Starting at T_J = 25°C
- 4. $I_{SD} \le 7A$, di/dt = 100A/us, $V_{DD} \le BV_{DSS}$, Starting at $T_J = 25^{\circ}C$

 Mounting consideration for TO220 Fullpack: M3 screw plus flat washer is suggested, free of burr between devices and contact area, the devices are to be mounted to a hole not larger than 3.6mm in contact diameter (chamfer included).

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| THERMAL CHARACTERISTICS | | | | |
|---|-------------------|-------|------|--|
| Parameter | Symbol | Value | Unit | |
| Thermal resistance, Junction to case | R _{thjc} | 0.75 | °C/W | |
| Thermal resistance, Junction to ambient | R _{thja} | 82 | °C/W | |

| ELECTRICAL CHARACTERISTICS ($T_c = 25^{\circ}C$ unless otherwise specified) | | | | | | |
|--|-----------------------------|--|------|------|------|------|
| Parameter | Symbol | Test conditions | Min. | Тур. | Max. | Unit |
| Off Characteristics | | | | | | |
| Drain to source breakdown voltage | BV _{DSS} | V _{GS} =0V, I _D =250uA | 650 | | | V |
| Breakdown voltage temperature coefficient | ΔBV _{DSS} / ΔTJ | I _D =250uA, referenced to 25°C | | 0.51 | | V/⁰C |
| Drain to acurac lockage current | | V _{DS} =650V, V _{GS} =0V | | | 1 | uA |
| Drain to source leakage current | I _{DSS} | V _{DS} =520V, T _C =125°C | | | 50 | uA |
| Gate to source leakage current, forward | 1 | V _{GS} =30V, V _{DS} =0V | | | 100 | nA |
| Gate to source leakage current, reverse | I _{GSS} | V _{GS} =-30V, V _{DS} =0V | | | -100 | nA |
| On Characteristics | | | | | | |
| Gate threshold voltage | V _{GS(TH)} | V _{DS} =V _{GS} , I _D =250uA | 2 | | 4 | V |
| Drain to source on state resistance | R _{DS(ON)} | V _{GS} =10V, I _D =3.5A | | 1.05 | 1.3 | Ω |
| Forward Transconductance | Gfs | V _{DS} = 30 V, I _D = 3.5 A | | 5.2 | | S |
| Dynamic Characteristics | | | | | | |
| Input capacitance | Ciss | | | 1100 | | |
| Output capacitance | Coss | V _{GS} =0V, V _{DS} =25V, f=1MHz | | 110 | | pF |
| Reverse transfer capacitance | C _{rss} | | | 15 | | |
| Turn on delay time | t _{d(on)} | | | 17 | | |
| Rising time | tr | -V _{DS} =380V, I _D =7Α,R _G =25Ω - | | 33 | | ns |
| Turn off delay time | t _{d(off)} | | | 82 | | 115 |
| Falltime | t _f | | | 41 | | |
| Total gate charge | Qg | | | 37 | | |
| Gate-source charge | Q _{gs} | V_{DS} =520V, V_{GS} =10V, I_{D} =7A | | 6 | | nC |
| Gate-drain charge | Q_{gd} | | | 12 | | |

| SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS | | | | | | |
|---|-----------------|---|------|------|------|------|
| Parameter | Symbol | Test conditions | Min. | Тур. | Max. | Unit |
| Continuous source current | ls | Integral reverse p-n Junction _ diode in the MOSFET | | | 7 | А |
| Pulsed source current | I _{SM} | | | | 28 | А |
| Diode forward voltage drop. | V_{SD} | I _S =7A, V _{GS} =0V | | | 1.2 | V |
| Reverse recovery time | T _{rr} | I _S =7A, V _{GS} =0V, dI _F /dt=100A/us | | 450 | | ns |
| Reverse recovery Charge | | | | 9.1 | | uC |

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Fig1. Output characteristics

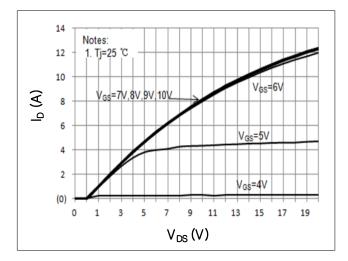
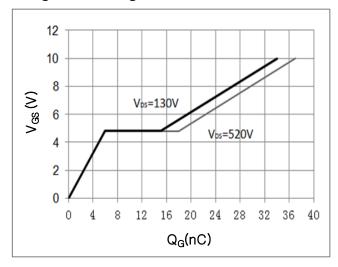
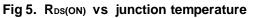


Fig3. Gate charge characteristics





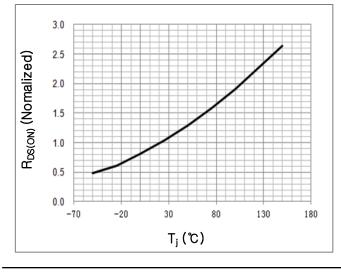


Fig2. Drain-source on-state resistance

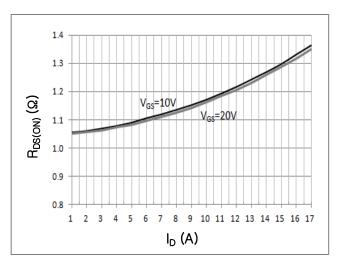


Fig 4. Capacitance Characteristics

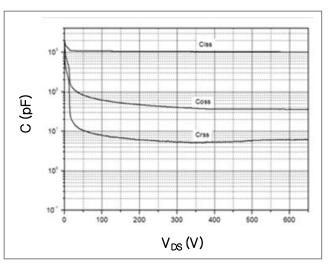
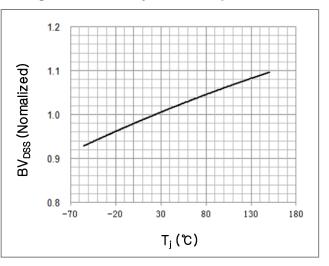


Fig 6. BVDss vs junction temperature



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Fig 8. Transient thermal impedance

Fig 7 . Safe operating area

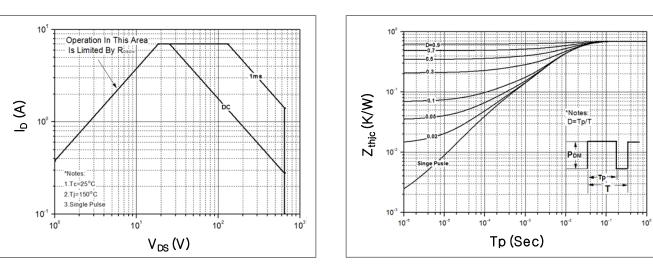


Fig 9. Forward characteristics of reverse diode

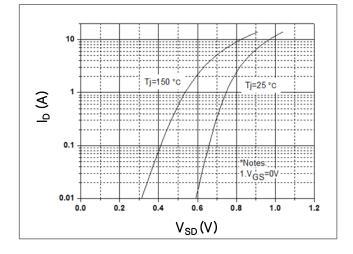
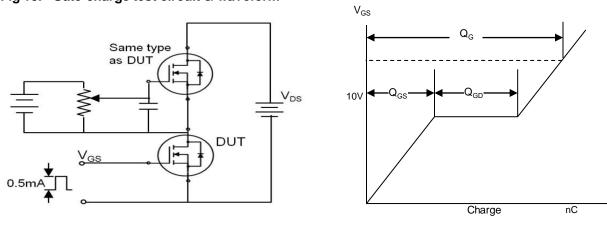


Fig 10. Gate charge test circuit & waveform



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Fig 11. Switching time test circuit & waveform

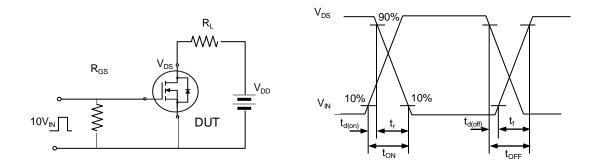


Fig 12. Unclamped Inductive switching test circuit & waveform

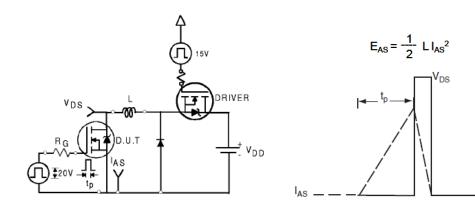
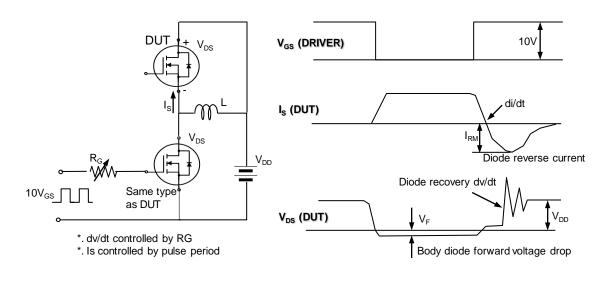


Fig 13. Peak diode recovery dv/dt test circuit & waveform



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